



### DMT6013LSS

#### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
60V	14.3mΩ @ V <sub>GS</sub> = 10V	10A
001	21mΩ @ V <sub>GS</sub> = 4.5V	8.1A

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(ON)})$  and maintain superior switching performance, making it ideal for high efficiency power management applications.

- High Frequency Switching
- Synchronous Rectification
- DC-DC Converters

#### SO-8

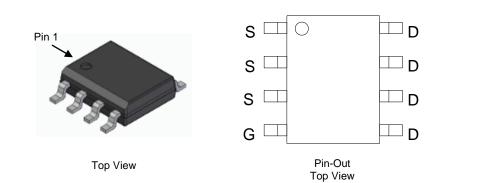
#### 60V N-CHANNEL ENHANCEMENT MODE MOSFET

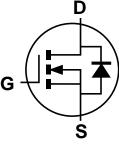
#### **Features and Benefits**

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.076 grams (Approximate)





Equivalent Circuit

#### Ordering Information (Note 4)

	Part Number	Case	Packaging
DMT6013LSS-13		SO-8	2500/Tape & Reel
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.			

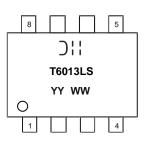
No purposely added lead. Fully ED Directive 2002/95/EC (ROHS), 2011/65/ED (ROHS 2) & 2015/863/ED (ROHS 3) compliant.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



 $C_{++} = Manufacturer's Marking$ T6013LS = Product Type Marking CodeYYWW = Date Code Marking $YY or <math>\overline{YY}$  = Year (ex: 19 = 2019) WW = Week (01 to 53)



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	60	V	
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 6) $V_{GS}$ = 10V	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	Ι <sub>D</sub>	10 7.8	А
Continuous Drain Current (Note 6) $V_{GS} = 4.5V$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		۱ <sub>D</sub>	8.1 6.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	60	A	
Maximum Continuous Body Diode Forward Current	Is	10	A	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cyc	I <sub>SM</sub>	60	A	
Avalanche Current (Note 7) L = 0.1mH		I <sub>AS</sub>	17.1	A
Avalanche Energy (Note 7) L = 0.1mH	E <sub>AS</sub>	14.6	mJ	

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	1.4	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	89.8	°C/W
Total Power Dissipation (Note 6)	PD	2.1	W
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>0</sub> JA	60.4	°C/W
Thermal Resistance, Junction to Case (Note 6)	R <sub>θJC</sub>	25.7	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

						-	
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)				-			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_		V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>		—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	—	2.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance			11.2	14.3	mΩ	$V_{GS} = 10V, I_D = 10A$	
	R <sub>DS(ON)</sub>		16.1	21		$V_{GS} = 4.5V, I_D = 6A$	
Diode Forward Voltage	V <sub>SD</sub>		0.7	1.2	V	$V_{GS} = 0V, I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss		1081	—		$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	Coss	_	253	—	pF		
Reverse Transfer Capacitance	Crss	_	22	—			
Gate Resistance	Rg		1.22	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	-	8.5	—			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	15	—	nC	V <sub>DS</sub> = 30V, I <sub>D</sub> = 10A	
Gate-Source Charge	Q <sub>gs</sub>	_	2.2	_	nc		
Gate-Drain Charge	Q <sub>gd</sub>	_	4.4	—			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	4.3	_			
Turn-On Rise Time	t <sub>R</sub>	_	6.5	_		$\label{eq:VGS} \begin{array}{l} V_{GS} = 10V, \ V_{DS} = 30V, \\ R_{G} = 6\Omega, \ I_{D} = 10A \end{array}$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	15.8		ns		
Turn-Off Fall Time	tF		6.1	—			
Reverse Recovery Time	t <sub>RR</sub>		19.7	—	ns		
Reverse Recovery Charge	Q <sub>RR</sub>	_	9.5	_	nC	$\frac{10}{nC}$ I <sub>F</sub> = 10A, di/dt = 100A/µs	

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:

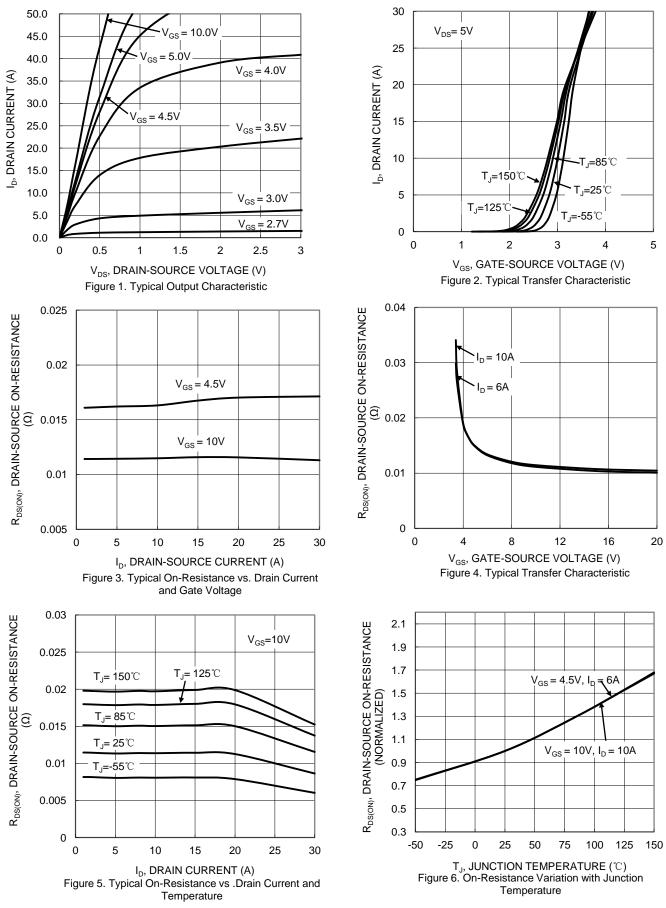
6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1 inch square copper plate.

7.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J = +25^{\circ}C$ .

Short Larston pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.

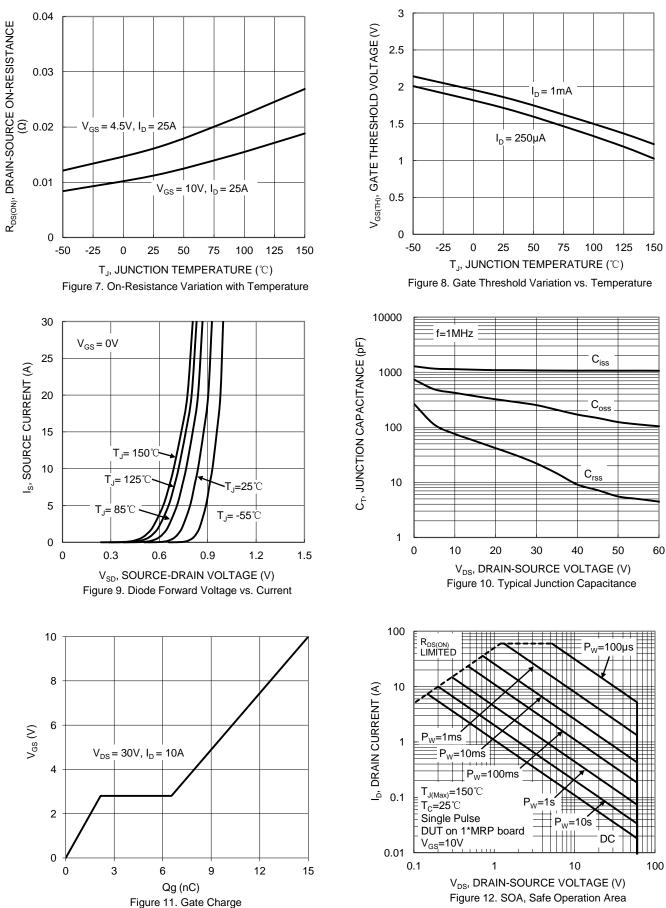


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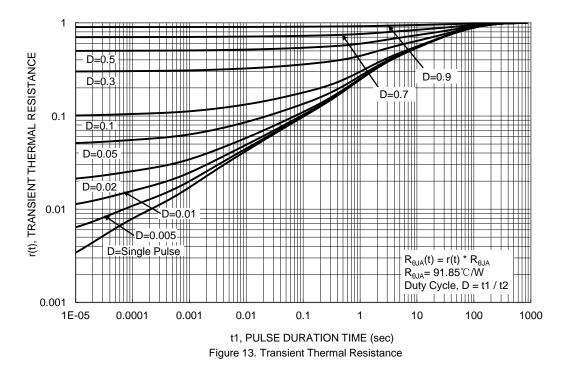


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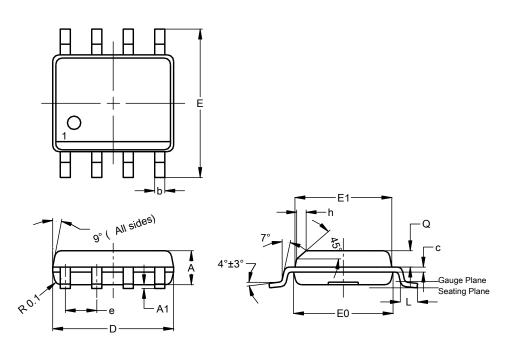






# **Package Outline Dimensions**

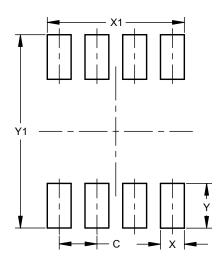
Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
υ	0.15	0.25	0.20		
D	4.85	4.95	4.90		
ш	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
e		-	1.27		
h	-		0.35		
┙	0.62	0.82	0.72		
q	0.60	0.70	0.65		
All Dimensions in mm					

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8

SO-8

Dimensions	Value (in mm)		
С	1.27		
Х	0.802		
X1	4.612		
Y	1.505		
Y1	6.50		



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